

## LGA80D

### Evaluation Test Board Digital DC-DC Converter



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- Overview
- Test Setup
- Supported Models
- Schematic
- BOM
- PCB Layout

## Descriptions

LGA80D-EVAL-KIT gives you the ability to connect the demonstration board to a USB socket on a PC, with the PMBus interface, dongle and cable provided in the kit to control and monitor the LGA80D units as they would be used in an application.

This document is a reference guide for the evaluation test board of the compatible series power supply. It is for evaluation purposes only. The evaluation board provides output terminals, test points to power signals, control signals and communication interface via I<sup>2</sup>C bus. Refer to the technical reference note of the power supply for more information about the specifications and the signal definitions.

## Overview

The key components and connection locations are shown in the picture of the evaluation board below. Note that the LGA80D shown at the 'top' of this picture is the one that is configured as the single output unit, and the 'bottom' converter is configured as a dual output module.

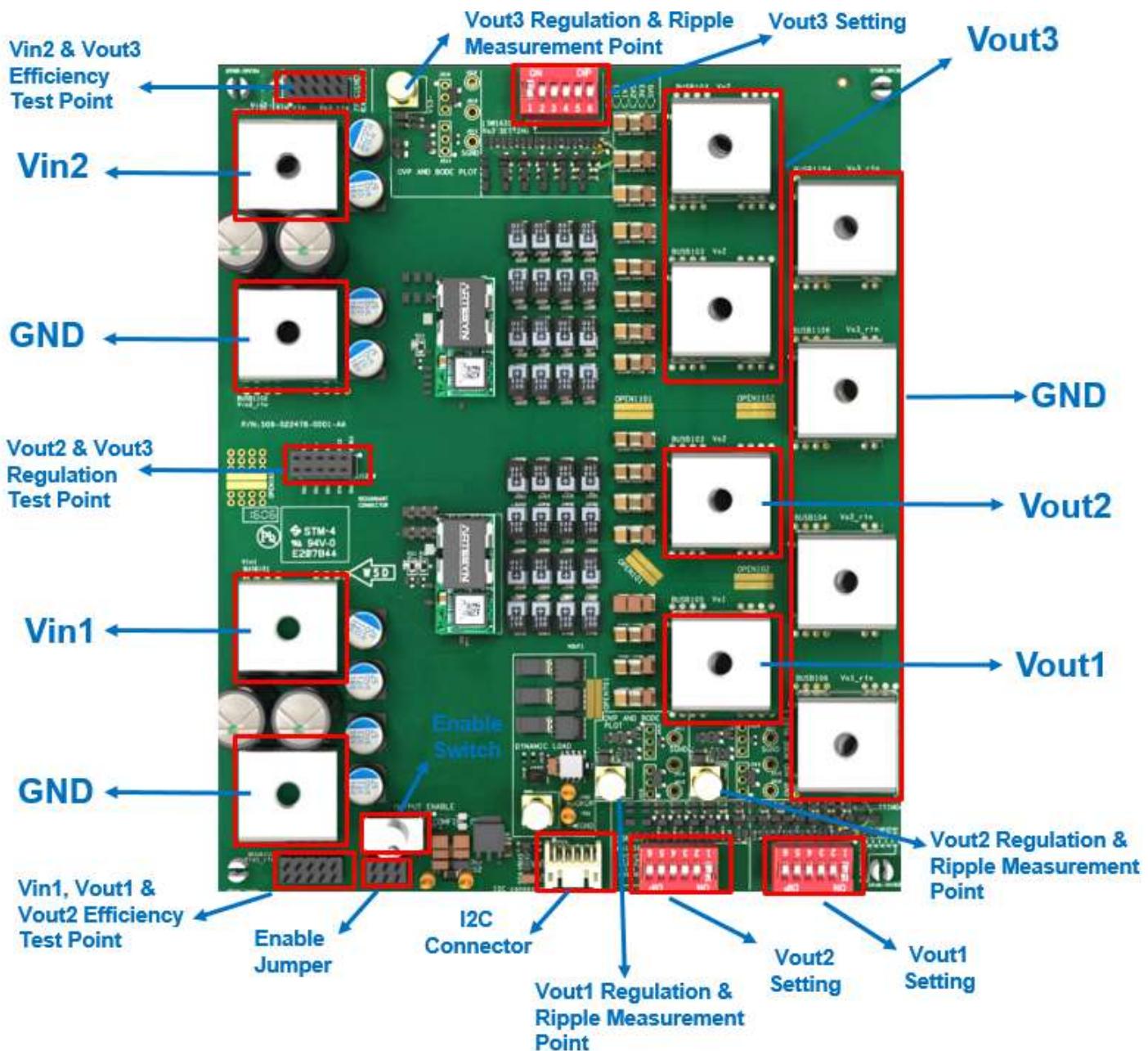


Figure 1. Evaluation Test Board for LGA80D

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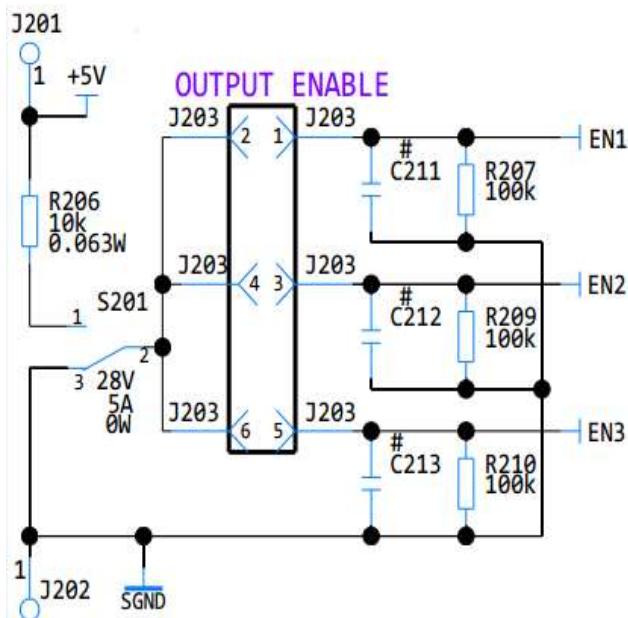
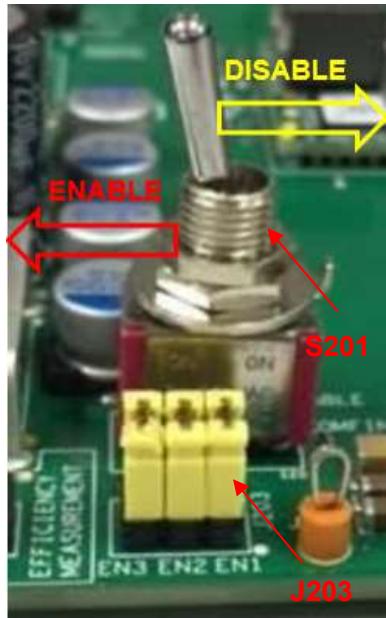
## Pin Assignment

| Item       | Pin Number | Designation                 | Functions                               |
|------------|------------|-----------------------------|---|
| Test Point | BUSB101    | $V_{IN1}$                   | Input terminal                          |
|            | BUSB102    | $V_{IN1\_ rtn}$             | Input return terminal                   |
|            | BUSB1101   | $V_{IN2}$                   | Input terminal                          |
|            | BUSB1102   | $V_{IN2\_ rtn}$             | Input return terminal                   |
|            | BUSB103    | $V_{O2}$                    | Output terminal                         |
|            | BUSB104    | $V_{O2\_ rtn}$              | Output return terminal                  |
|            | BUSB105    | $V_{O1}$                    | Output terminal                         |
|            | BUSB106    | $V_{O1\_ rtn}$              | Output return terminal                  |
|            | BUSB1103   | $V_{O3}$                    | Output terminal                         |
|            | BUSB1104   | $V_{O3\_ rtn}$              | Output return terminal                  |
|            | BUSB1105   | $V_{O3}$                    | Output terminal                         |
|            | BUSB1106   | $V_{O3\_ rtn}$              | Output return terminal                  |
|            | J205       | $V_{IN1}, V_{O1} \& V_{O2}$ | Efficiency test point                   |
|            | J1205      | $V_{IN2} \& V_{O3}$         | Efficiency test point                   |
|            | J1206      | $V_{O2} \& V_{O3}$          | Regulation test point                   |
| Jumper     | J303       | $V_{O2}$                    | Regulation and Ripple measurement point |
|            | J403       | $V_{O1}$                    | Regulation and Ripple measurement point |
|            | J1403      | $V_{O3}$                    | Regulation and Ripple measurement point |
| Switch     | J203       | Enable Jumper               | Output Enable                           |
| Switch     | S201       | Enable Switch               | Output Enable                           |
|            | SW601      | $V_{O1}$                    | $V_{O1}$ setting                        |
|            | SW631      | $V_{O2}$                    | $V_{O2}$ setting                        |
|            | SW1601     | $V_{O3}$                    | $V_{O3}$ setting                        |
| Connector  | J204       | I <sup>2</sup> C Connector  | I <sup>2</sup> C Communication          |

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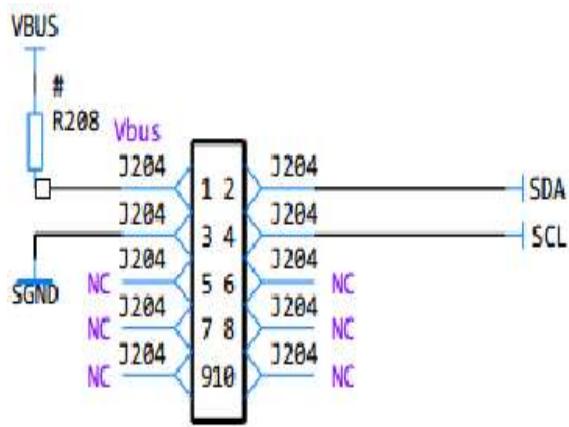
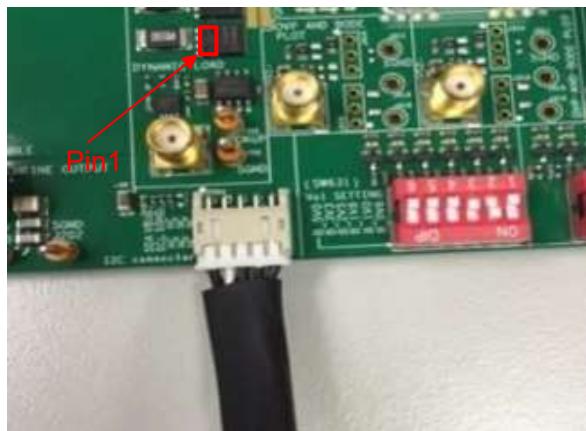
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## LGA80D Output Enable Connection (S201, J203)



**Notes:** S201 and J201 work with each other. S201 is used to enable / disable the output of LGA80D (2 modules, 3 outputs), if EN1 of J201 is connected, the Vout1 will be enabled /disabled, if EN1, EN2 & EN3 are connected, Vout1, Vout2 & Vout3 will be all enabled /disabled.

### **LGA80D I2C Connection (J204)**

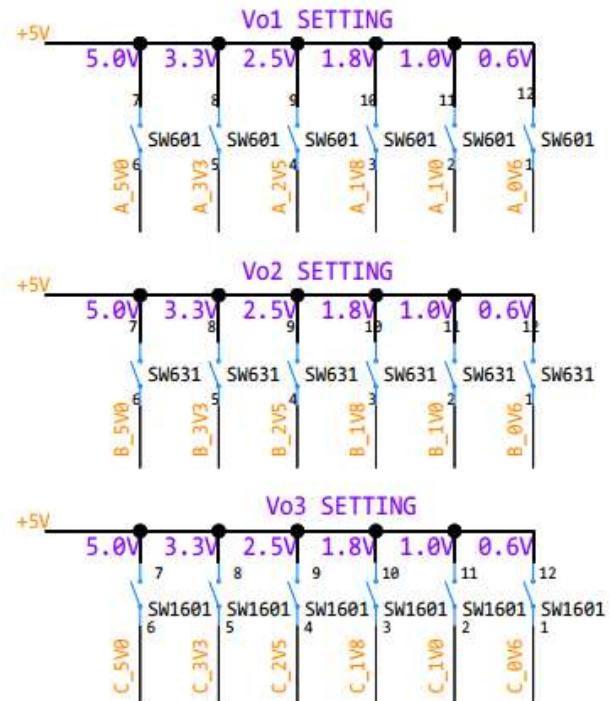
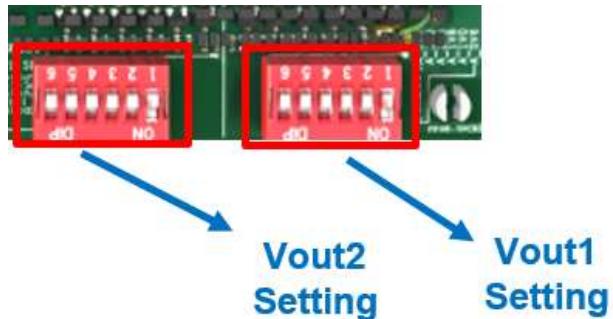


| Pin Number | Designation | Pin Number | Designation |
|------------|-------------|------------|-------------|
| 1          | VBUS        | 6          | NC          |
| 2          | SDA         | 7          | NC          |
| 3          | SGND        | 8          | NC          |
| 4          | SCL         | 9          | NC          |
| 5          | NC          | 10         | NC          |

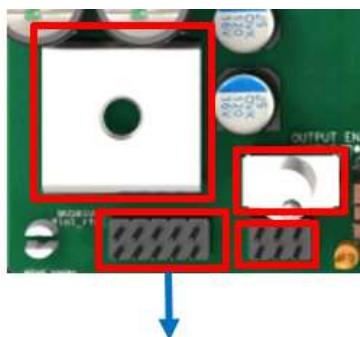
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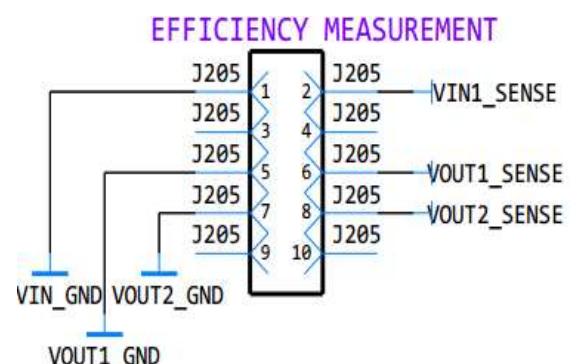
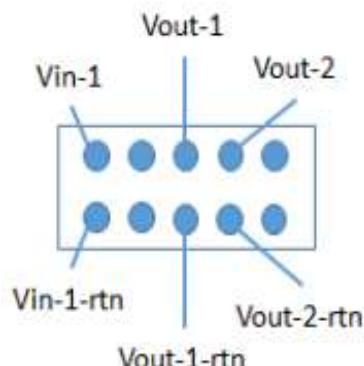
## LGA80D Voltage Setting (SW601, SW631, SW1601)



## LGA80D Efficiency Test Point (J205, J1205)



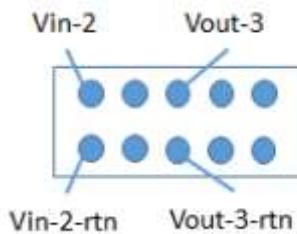
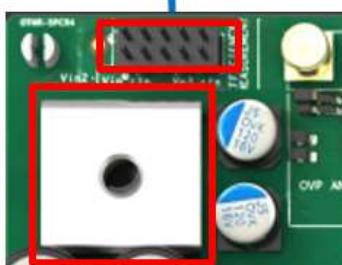
**Vin1, Vout1 & Vout2 Efficiency Test Point**



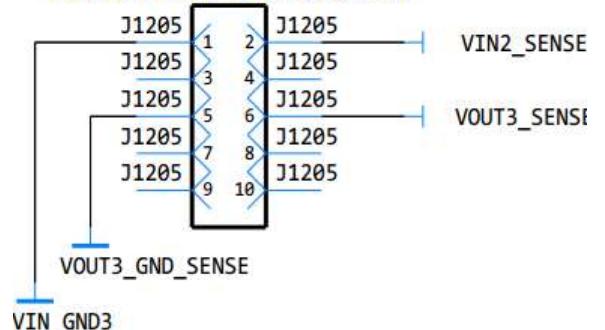
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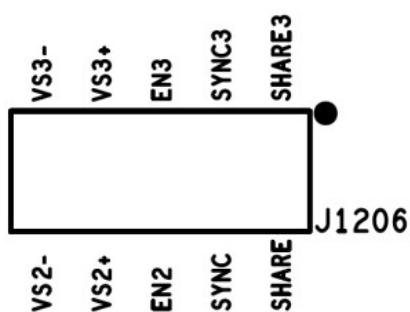
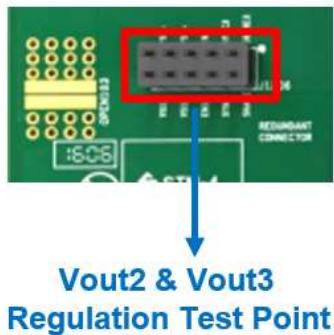
## Vin2 & Vout3 Efficiency Test Point



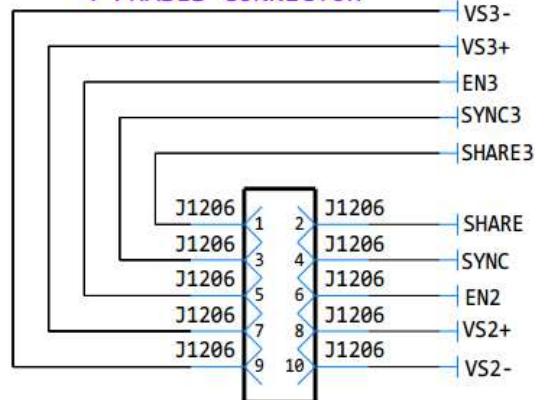
## EFFICIENCY MEASUREMENT



## 5. LGA80D Regulation Test Point (J1206)



## 4 PHASES CONNECTOR



## Test Setup

### Hardware Test Setup

The LGA80D can be connected with the E-load via the Vout and Return terminals, and communicates with LGA80D GUI through the I<sup>2</sup>C connector J204.

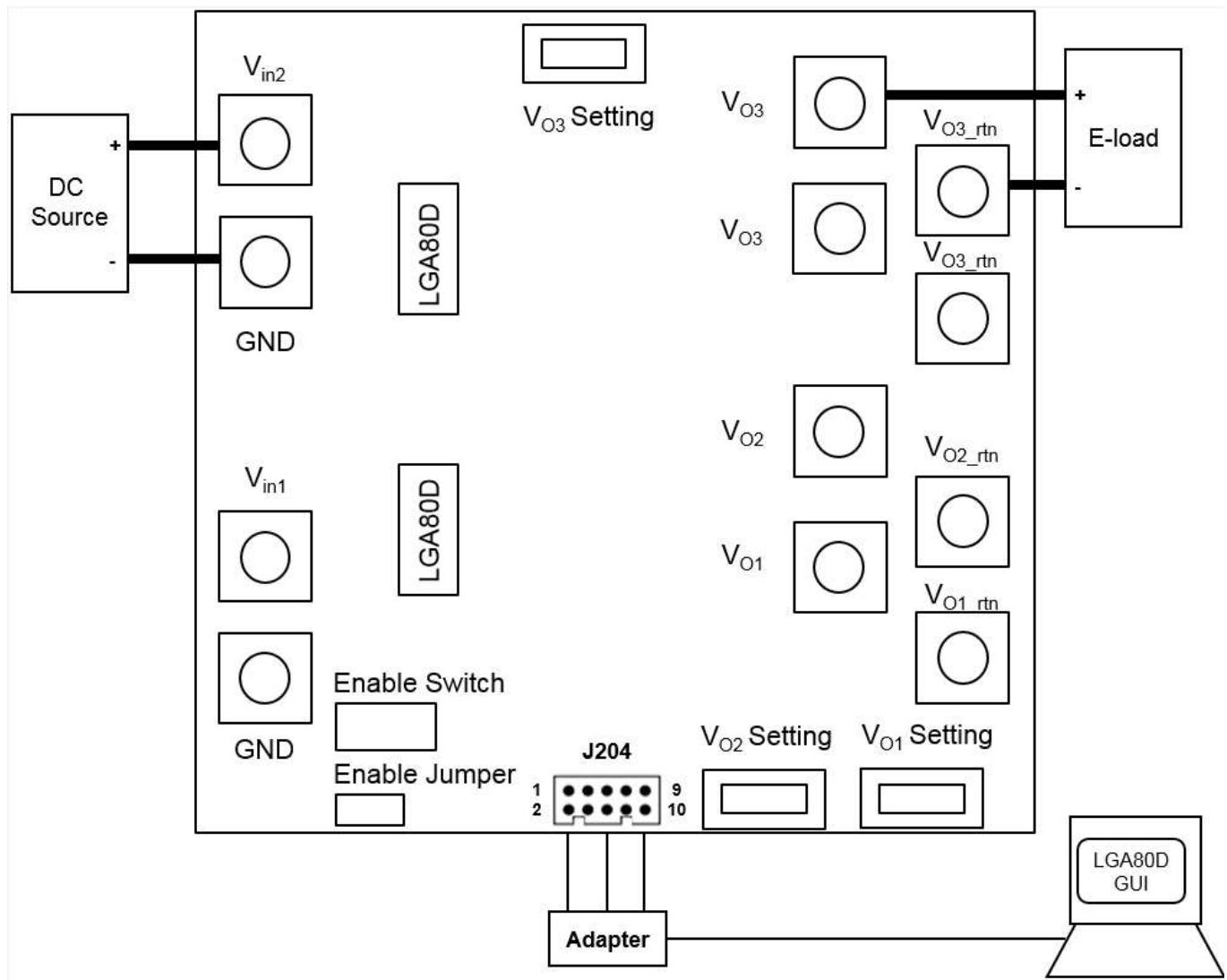


Figure 2. Hardware Interface Setup

Assumption: The user has made the power connections to and from the evaluation card. These will not be described further.

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### Software Test Setup

The LGA80D has an evaluation software, LGA80D GUI, designed to make the unit accessible to the user. It is intended to control and monitor the LGA80D units as they would be used in an application.

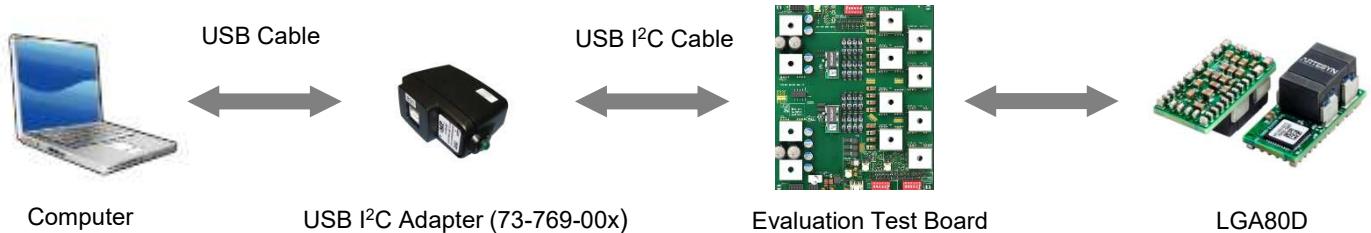


Figure 3. Software Interface Setup

The LGA80D GUI must be installed on a PC before using all of the functions of this program. Please refer to the Figure 4.

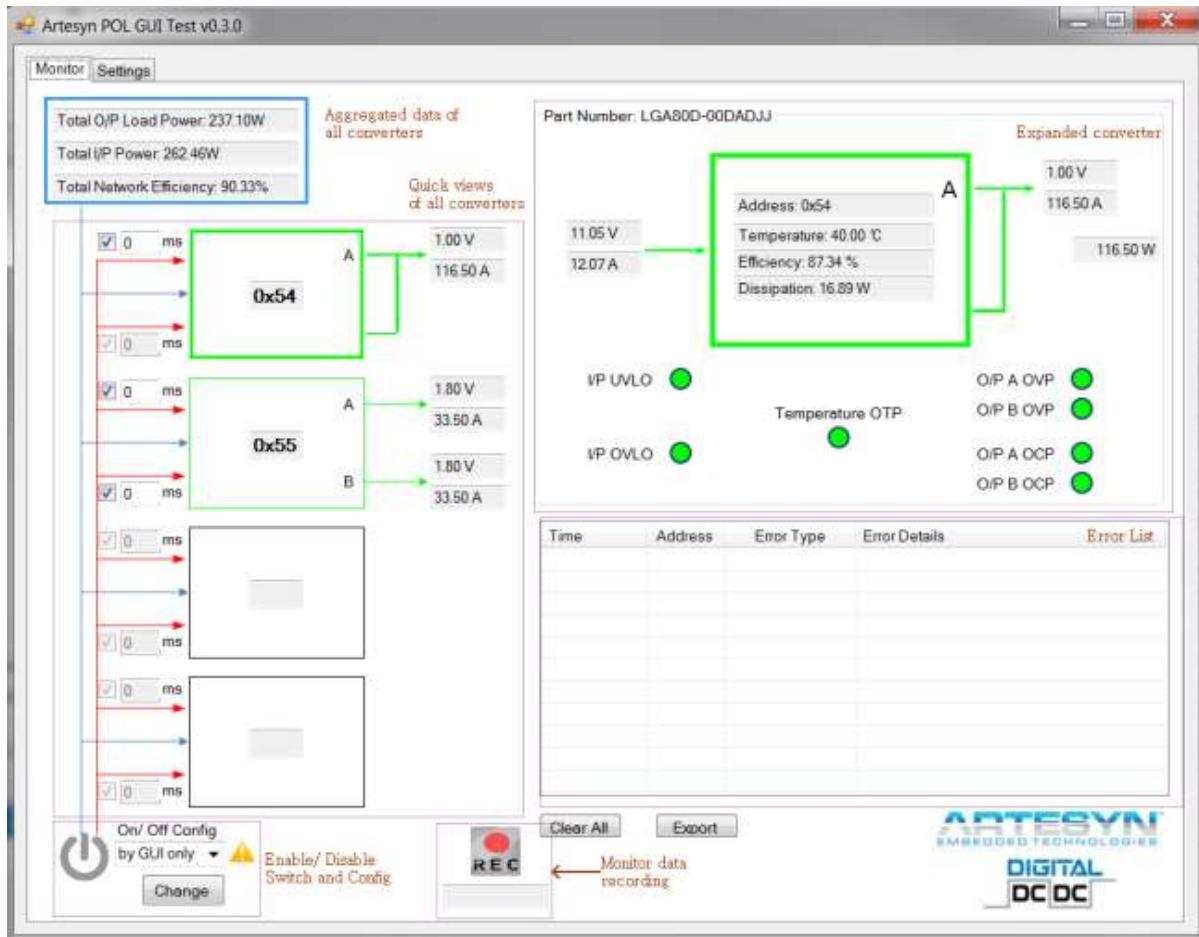


Figure 4. Universal PMBus™ GUI

## Hardware Test Setup

The setup example is shown in figure 5. It contains the input cord, LGA80D, evaluation test board, USB to I<sup>2</sup>C adapter and computer. The adapter is required to connect the unit to the computer. The Artesyn USB-to-I<sup>2</sup>C interface adapter P/N is 73-769-001 or 73-769-002.

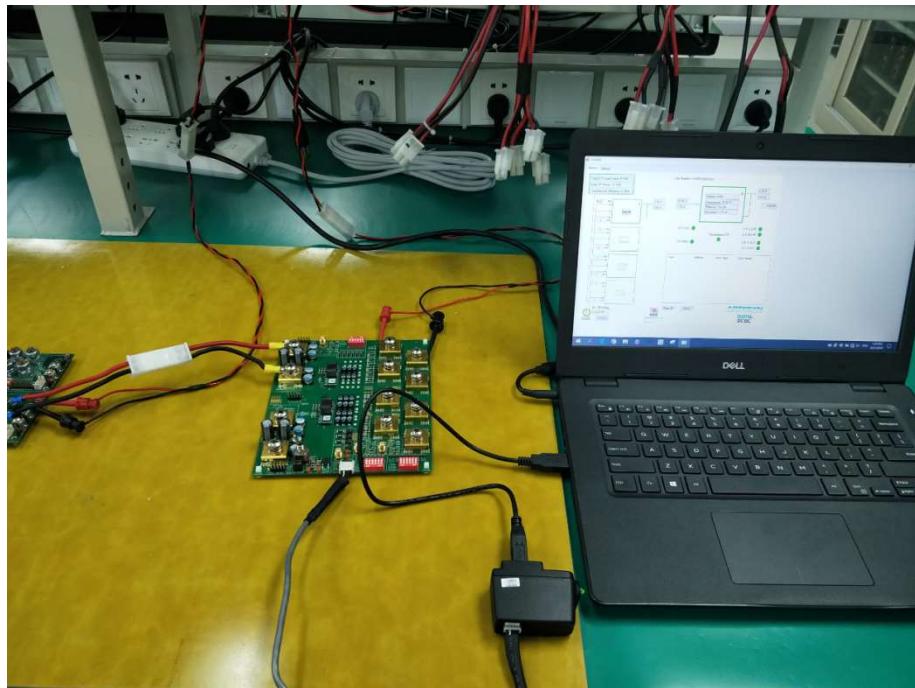


Figure 5. Setup Example

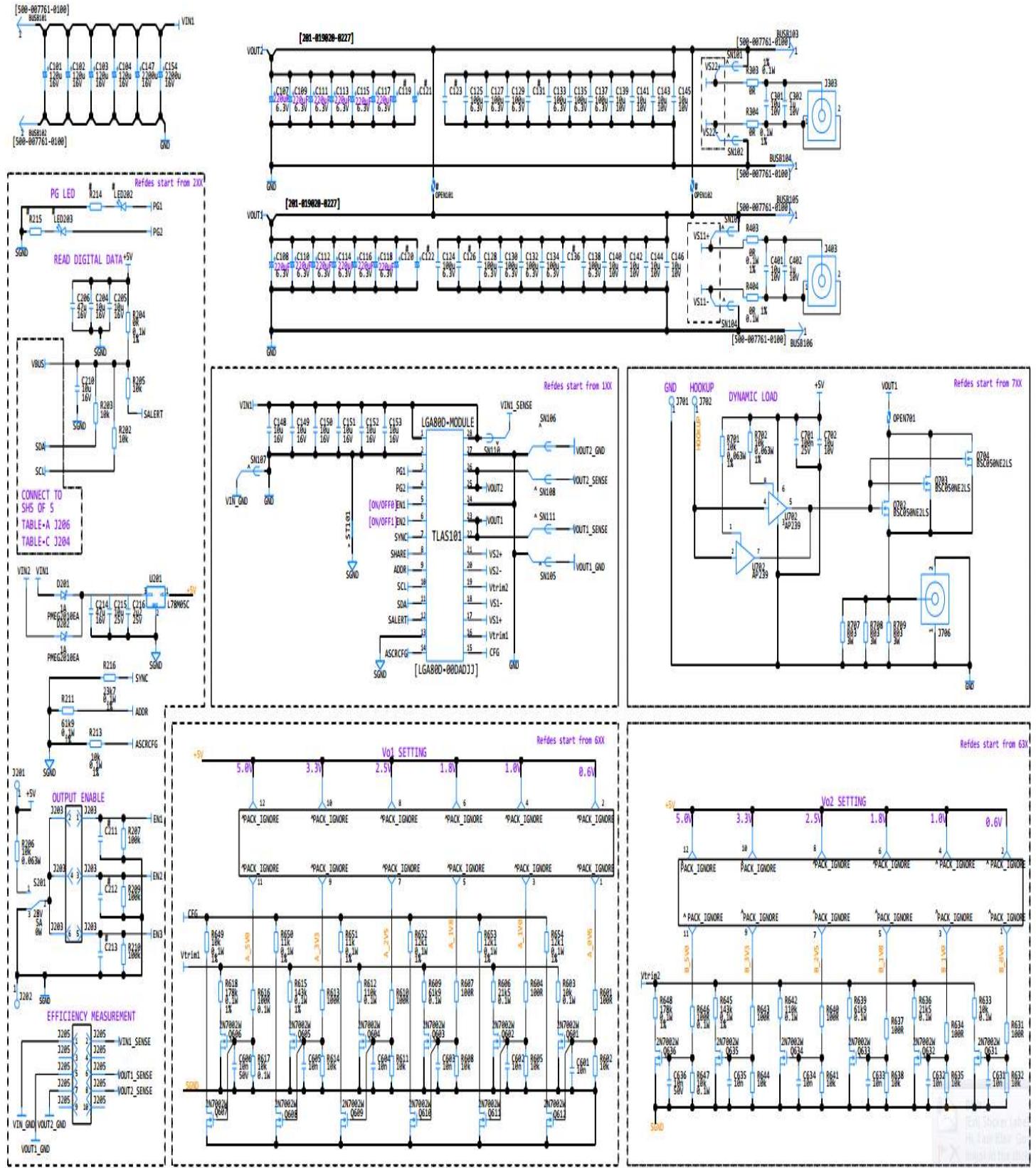
## Supported Models

| Part Number    | Description  |
|----------------|--|
| LGA80D-00DADJJ | Dual O/P Non-isolated 80 A Digital DC/DC Converter |

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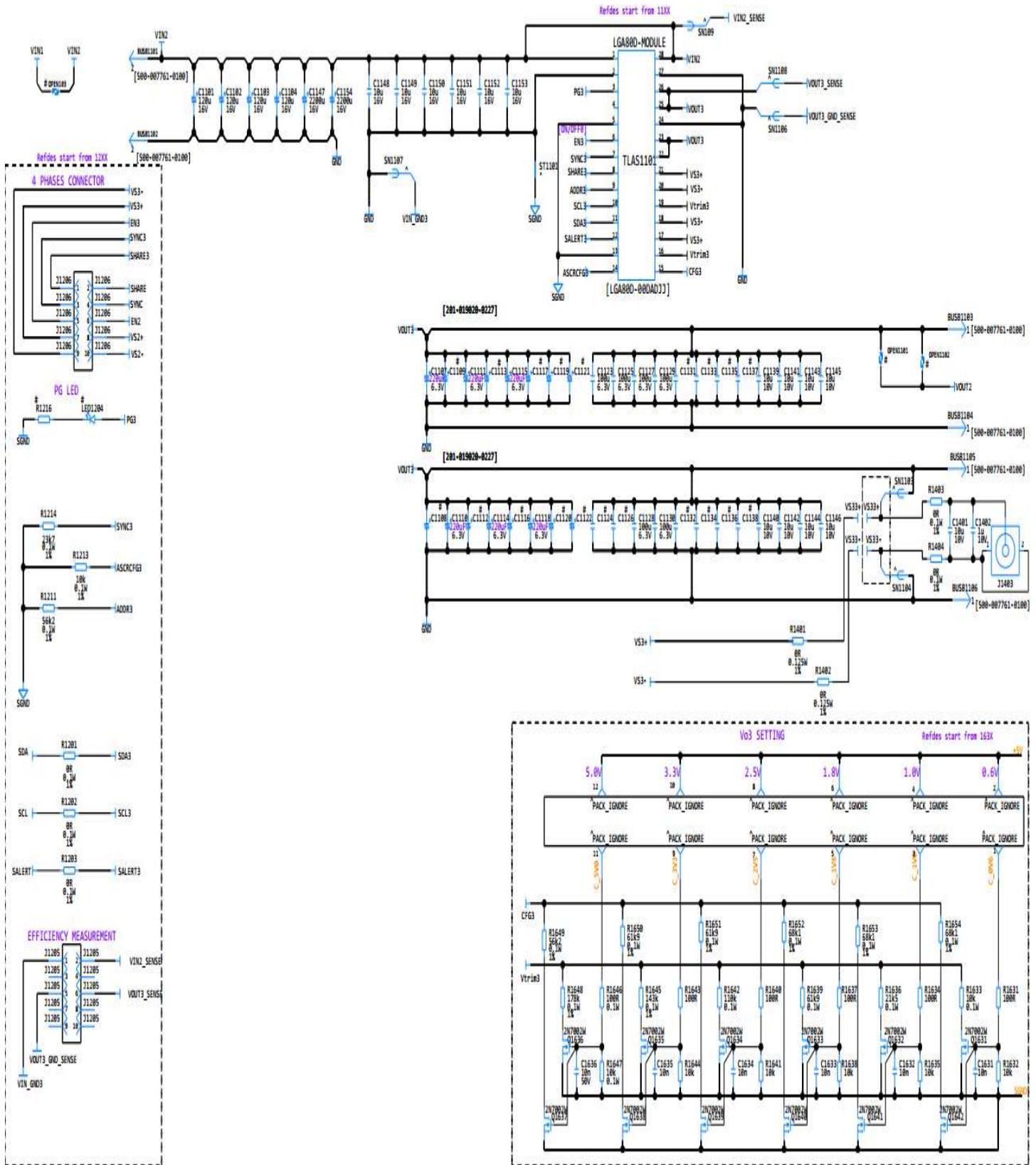
## Schematic



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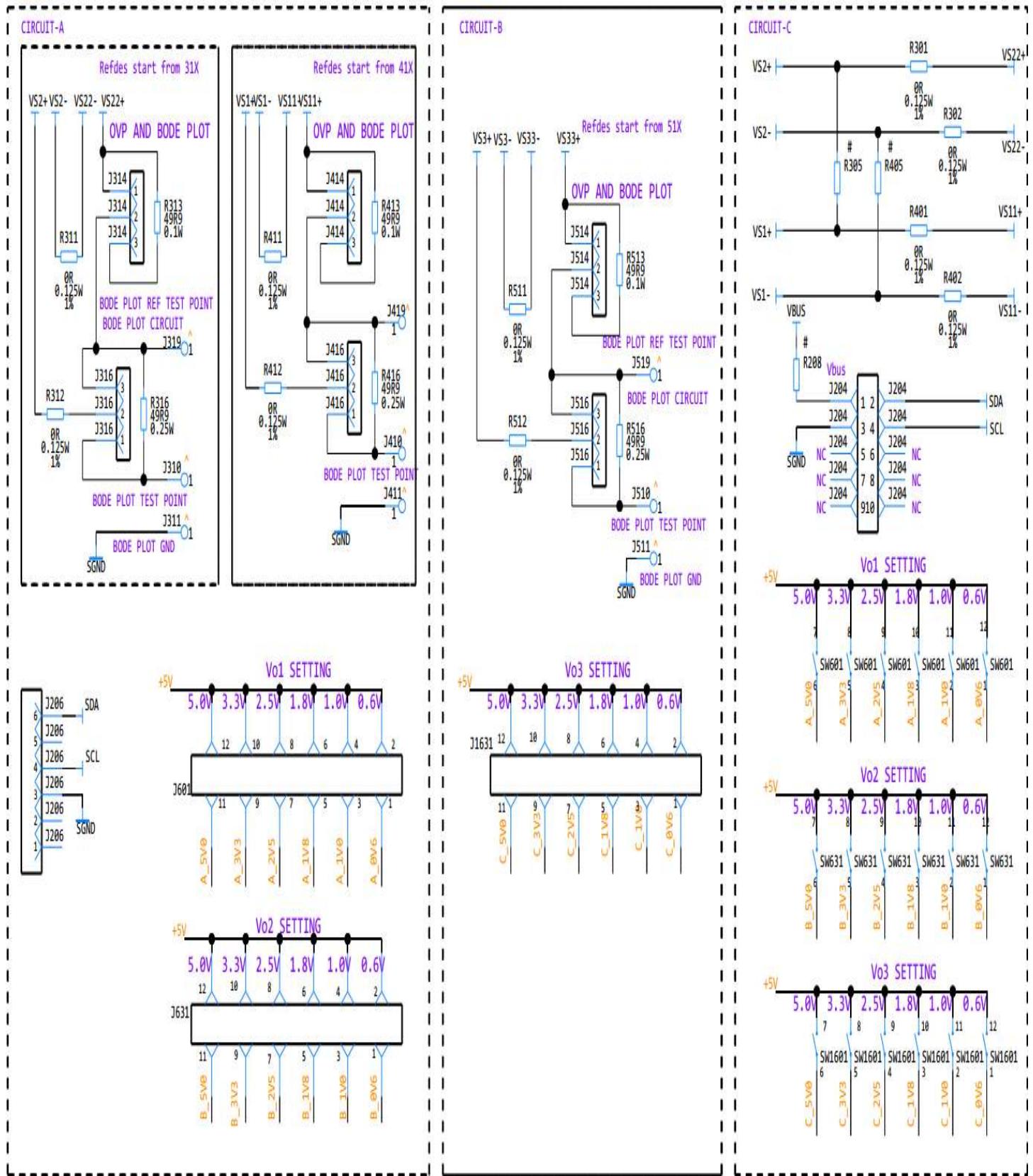
## Schematic



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## Schematic



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### LGA80D Test Board BOM

| Item | Qty | Manufacture P/N | Description  | Manufacture                                | Reference   | Part               |
|------|-----|-----------------|--|--|---|--------------------|
| 1    | 1   | LGA80D-EVAL-KIT | ARTESYN LGA80D Test Board (PCB), 8 layers  | Advanced Circuits                          | 8 Layers_PCB  | ARTESYN LGA80D     |
| 2    | 3   | F800102         | CONN,HDR,FEM, STRAIGHT,2,2.54 mm,3A,GOLD,2.54 MM MINI JUMPER                                     | LANDWIN                                    | OTHR1<br>OTHR2<br>OTHR3   | F800102            |
| 3    | 4   | ETS-3(V0)-1     | MECH. OTHR PUR, OTHR, MOUNTING, PLASTIC CONICAL ANCHORS, N66, V0                                 | KANG YANG                                  | OTHR-SPCR1<br>OTHR-SPCR2<br>OTHR-SPCR3<br>OTHR-SPCR4  | ETS-3(V0)-1        |
| 4    | 12  | EME-SW-0616     | FSTNR, MTL MET, SEMS, SST, OTHER, PAN HEAD, CROSS RECESS (PHILLIPS), M6 X 1,12mm, PLAIN & SPRING | VICTOR METAL PRODUCTS (HK) COMPANY LIMITED | SCRW1<br>SCRW2<br>SCRW3<br>SCRW4<br>SCRW5<br>SCRW6<br>SCRW7<br>SCRW8<br>SCRW9<br>SCRW10<br>SCRW11<br>SCRW12 | EME-SW-0616        |
| 5    | 4   | ZLH 10X20_EFC   | CAP, ELECT, LIMPD, 1500µF, 16VDC, 20%, -20%, 10 X 20   | RUBYCON                                    | C147<br>C154<br>C1147<br>C1154  | 35ZLH560MEFC 10X20 |
| 6    | 3   | NDS-06V         | SWI, MECH, SLD, SLIDE, SPST, 25mA, 999W, 999V, 24VDC   | DIPTRONICS MANUFACTURING                   | SW601<br>SW631<br>SW1601  | NDS-06V            |
| 7    | 1   | T801x-SEC       | SWI, MECH, TOG, TOGGLE, SPDT, 5A, 0W, 125V, 0VDC   | SALECOM                                    | S201  | T801x-SEC          |
| 8    | 1   | 2052P1000T-01   | CONN, HDR, M, RIGHT-ANGLE, 10,2mm, 3A, SOLDER TAIL, TIN, N/A                                     | LANDWIN                                    | J204  | 2052P1000T-01      |
| 9    | 1   | 7313P06011-6    | CONN, HDR, M, STRAIGHT, 6, 2.54mm, 3A, SOLDER TAIL, GOLD, PIN HEADER                             | LANDWIN                                    | J203  | 7313P06011-6       |

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| Item | Qty | Manufacture P/N      | Description  | Manufacture  | Reference  | Part                 |
|------|-----|----------------------|--|--|--|----------------------|
| 10   | 1   | GPHA201-0502A001B1BA | CONN,HDR,M, STRAIGHT,10,2, 2.54mm,SOLDER TAIL,GOLD,DUAL ROW PIN HEADER | GREENCONN ELECTRONIC TECHNOLOGY (SUZHOU) CO., LTD. | J205<br>J1205<br>J1206   | GPHA201-0502A001B1BA |
| 11   | 4   | 5013                 | CONN,OTHR,MALE, STRAIGHT,1,0mm, TIN,ORANGE TEST POINT                  | KEYSTONE ELECTRONICS CORP.                         | J201<br>J202<br>J701<br>J702   | 5013                 |
| 12   | 12  | 500-007761-TABD      | MECH,FAB MET,BUSBAR,CU, STMP,BUSBAR TEST-JIG OUTPUT                    | ARTESYN  | BUSB101<br>BUSB102<br>BUSB103<br>BUSB104<br>BUSB105<br>BUSB106<br>BUSB1101<br>BUSB1102<br>BUSB1103<br>BUSB1104<br>BUSB1105<br>BUSB1106 | 500-007761-TABD      |
| 13   | 1   | AP239TR              | IC,ANALOG,DRV, SOIC8   | STMICROELECTRONICS                                 | U702   | AP239TR              |
| 14   | 1   | LF33ABDT-TR          | IC,VREG, LDO-FXD,LF33AB, 3.3V,1%,1A,125° C, TO252 (DPAK)               | STMICROELECTRONICS ASIA                            | U201   | LF33ABDT-TR          |
| 15   | 3   | BSC009NE2LS          | XSTR,FET,NLVMOS ,25V,0.9mΩ,100A, BSC009NE2, PG-TDS0N-8                 | INFINEON   | Q702<br>Q703<br>Q704   | BSC009NE2LS          |
| 16   | 18  | 2N7002KW             | XSTR,FET, NLVMOS,60V,1.6Ω, 0.31A,2N7002W, SOT323 (SC-70)               | ON SEMICONDUCTOR                                   | Q601 Q602<br>Q603 Q604<br>Q605 Q606<br>Q607 Q608<br>Q609 Q610<br>Q611 Q612<br>Q631 Q632<br>Q634 Q635<br>Q636 Q1631                     | 2N7002KW             |

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| Item | Qty | Manufacture P/N       | Description   | Manufacture               | Reference   | Part                  |
|------|-----|-----------------------|---|---------------------------|---|-----------------------|
| 16   | 11  | 2N7002KW              | XSTR,FET,<br>NLVMOS,60V,1.6Ω,<br>0.31A,2N7002W,<br>SOT323 (SC-70) | ON SEMICONDUCTOR          | Q1632 Q1633<br>Q1634 Q1635<br>Q1636 Q1637<br>Q1638 Q1639<br>Q1640 Q1641<br>Q1642  | 2N7002KW              |
| 17   | 18  | 0603B821K500CT        | CAP,CER,X7R,10nF<br>,50VDC,10%,<br>-10%,0603                      | WALSIN                    | C601 C602<br>C603 C604<br>C605 C606<br>C631 C632<br>C633 C634<br>C635 C636<br>C1631 C1632<br>C1633 C1634<br>C1635 C1636 | 0603B821K500CT        |
| 18   | 18  | CL32X107MQVNN<br>NE   | CAP,CER,X6S,100<br>μF,6.3VDC,20%,<br>-20%,1210                    | SAMSUNG ELECTRO-MECHANICS | C124 C125<br>C127 C128<br>C129 C130<br>C132 C133<br>C134 C135<br>C137 C138<br>C1123 C1125<br>C1127 C1128<br>C1129 C1130 | CL32X107MQVNN<br>NE   |
| 19   | 3   | CL21B105KAFNFN<br>E   | CAP,CER,X7R,10μF<br>,10VDC,10%,<br>-10%,0805                      | SAMSUNG ELECTRO-MECHANICS | C301<br>C401<br>C1401   | CL21B105KAFNFN<br>E   |
| 20   | 4   | CC1206KKX7R8BB<br>475 | CAP,CER,X7R,2.2<br>μF,25VDC,10%,<br>-10%,1206                     | YAGEO                     | C204<br>C205<br>C210<br>C216  | CC1206KKX7R8BB<br>475 |
| 21   | 3   | CC0603KRX7R8BB<br>563 | CAP,CER,X5R,1μF,<br>10VDC,±15%,10%,<br>-10%,0603                  | YAGEO                     | C302<br>C402<br>C1402   | CC0603KRX7R8B<br>B563 |
| 22   | 1   | CC0402KRX7R9BB<br>332 | CAP,CER,X7R,<br>100nF,25VDC,10%,<br>-10%,0402                     | YAGEO                     | C701  | CC0402KRX7R9B<br>B332 |
| 23   | 1   | TMK316AB7106KL-T      | CAP,CER,X7R,<br>10μF,25VDC,10%,<br>-10%,1206                      | TAIYO YUDEN               | C215  | TMK316AB7106KL-T      |

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| Item | Qty | Manufacture P/N     | Description  | Manufacture               | Reference   | Part                |
|------|-----|---------------------|--|---------------------------|---|---------------------|
| 24   | 2   | C1210C476M4PAC TU   | CAP,CER,X5R,<br>47µF,16VDC,20%,<br>-20%,1210                 | KEMET                     | C206 C214   | C1210C476M4PAC TU   |
| 25   | 8   | APXS160ARA121M H70G | CAP,ELECT,POLY,<br>120µF,16VDC,20%,<br>-20%,8 X 6.7          | NIPPON CHEMI-CON          | C101 C102<br>C103 C104<br>C1101 C1102<br>C1103 C1104  | APXS160ARA121 MH70G |
| 26   | 17  | C1206C222K1RAC TU   | CAP,CER,X7R,10µF<br>,10VDC,10%,<br>-10%,1206                 | KEMET                     | C139 C140<br>C141 C142<br>C143 C144<br>C145 C146<br>C702 C1139<br>C1140 C1141<br>C1142 C1143<br>C1144 C1145<br>C1146    | C1206C222K1RAC TU   |
| 27   | 12  | CL21B105KAFNFE      | CAP,CER,X7R,10µF<br>,16VDC,10%,<br>-10%,0805                 | SAMSUNG ELECTRO-MECHANICS | C148 C149<br>C150 C151<br>C152 C153<br>C1148 C1149<br>C1150 C1151<br>C1152 C1153  | CL21B105KAFNFE      |
| 28   | 18  | 6TPF220M5L          | CAP,OTHR,SPCLP<br>OLY,220µF,6.3VDC,<br>20%,-20%,<br>TANTALUM | PANASONIC                 | C107 C108<br>C109 C110<br>C111 C112<br>C113 C114<br>C115 C116<br>C117 C118<br>C1107 C1110<br>C1111 C1114<br>C1115 C1118 | 6TPF220M5L          |
| 29   | 4   | 0402WGF1803TCE      | RES,DIS,TKF,10KΩ,<br>0.063W,1%,100ppm<br>[TC],0402           | ROYAL                     | R202 R203<br>R205 R206  | 0402WGF1803TCE      |
| 30   | 3   | 0402WGF1803TCE      | RES,DIS,TKF,100<br>KΩ,0.063W,1%,<br>100ppm [TC],0402         | ROYAL                     | R207 R209<br>R210   | 0402WGF1803TCE      |
| 31   | 6   | 0603WAF2700T5E      | RES,DIS,TKF,0Ω,<br>0.1W,5%,<br>100ppm [TC],0603              | ROYALOHM                  | R204 R303<br>R304 R403<br>R404 R1201  | 0603WA              |

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| Item | Qty | Manufacture P/N | Description   | Manufacture | Reference   | Part                |
|------|-----|-----------------|---|-------------|---|---------------------|
| 31   | 4   | 0603WAF2700T5E  | RES,DIS,TKF,0Ω,<br>0.1W,5%,<br>100ppm [TC],0603     | ROYALOHM    | R1202 R1203<br>R1403 R1404  | 0603WAF2700T5E      |
| 32   | 18  | 0603SAF6491T5E  | RES,DIS,TKF,100Ω,<br>0.1W,1%,200ppm<br>[TC],0603    | ROYALOHM    | R601 R604<br>R607 R610<br>R613 R616<br>R631 R634<br>R637 R640<br>R643 R646<br>R1631 R1634<br>R1637 R1640<br>R1643 R1646                                     | 0603SAF6491T5E      |
| 33   | 23  | 0603WAF2700T5E  | RES,DIS,TKF,10KΩ,<br>0.1W,1%,100ppm<br>[TC],0603    | ROYALOHM    | R213 R602<br>R603 R605<br>R608 R611<br>R614 R617<br>R632 R633<br>R635 R638<br>R641 R644<br>R647 R1213<br>R1632 R1633<br>R1635 R1638<br>R1641 R1644<br>R1647 | 0603WAF2700T5E      |
| 34   | 6   | 0603SAF6491T5E  | RES,DIS,TKF,12.1K<br>Ω,0.1W,1%,100ppm<br>[TC],0603  | ROYALOHM    | R649 R650<br>R651 R652<br>R653 R654   | 0603SAF6491T5E      |
| 35   | 3   | 0603WAF2700T5E  | RES,DIS,TKF,110K<br>Ω,0.1W,1%,100ppm<br>[TC],0603   | ROYALOHM    | R612 R642<br>R1642  | 0603WAF2700T5E      |
| 36   |     | RC0603FR-071R1L | RES,DIS,TKF,143K<br>Ω,0.1W,1%,100ppm<br>[TC],0603   | YAGEO       | R615 R645<br>R1645  | RC0603FR-<br>071R1L |
| 37   | 3   | 0603WAF2700T5E  | RES,DIS,TKF,178<br>KΩ,0.1W,1%,100<br>ppm [TC],0603  | ROYALOHM    | R618 R648<br>R1648  | 0603WA              |
| 38   | 3   | RM06FTN1002     | RES,DIS,TKF,21.5<br>KΩ,0.1W,1%,100<br>ppm [TC],0603 | TA-I        | R606 R636<br>R1636  | RM06FTN1002         |
| 39   | 2   | RC0603FR-071R1L | RES,DIS,TKF,23.7<br>KΩ,0.1W,1%,100<br>ppm [TC],0603 | YAGEO       | R216 R1214  | RC0603FR-<br>071R1L |

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| Item | Qty | Manufacture P/N   | Description                                  | Manufacture               | Reference   | Part            |
|------|-----|-------------------|--|---------------------------|---|-----------------|
| 40   | 1   | WR06W1R00FTL      | RES,DIS,TKF,56.2KΩ,0.1W,1%,100ppm [TC],0603  | WALSIN                    | R1211   | WR06W1R00FTL    |
| 41   | 4   | 0603SAF6491T5E    | RES,DIS,TKF,61.9KΩ,0.1W,1%,100ppm [TC],0603  | ROYALOHM                  | R211 R639      R609 R1639                                   | 0603SAF6491T5E  |
| 42   | 6   | RC0603FR-071R1L   | RES,DIS,TKF,68.1KΩ,0.1W,1%,100ppm [TC],0603  | YAGEO                     | R1649 R1651 R1653      R1650 R1652 R1654                    | RC0603FR-071R1L |
| 43   | 6   | RM10FTN1000       | RES,DIS,TKF,0Ω,0.125W,1%,100ppm [TC],0805    | TA-I                      | R301 R401 R1401      R302 R402 R1402                        | RM10FTN1000     |
| 44   | 2   | RK73H1ERTTP100F   | RES,DIS,TKFS,10KΩ,0.063W,1%,200ppm [TC],0402 | KOA                       | R701      R702  | RK73H1ERTTP100F |
| 45   | 3   | RLP25FECCR100     | RES,DIS,PWR MTL STRP,30mΩ,3W,1%,75ppm [TC]   | TA-I                      | R707 R709      R708   | RLP25FECCR100   |
| 46   | 2   | CSD95490Q5MC      | IC,ANLG,DRV,125°C,CSD95490Q5 MC,DFN22        | TEXAS INSTRUMENTS         | U1      U2  | CSD95490Q5MC    |
| 47   | 1   | ZL8802ALAFT       | IC,DGTL,CNTLR,125°C,ZL8802,QFN44             | INTERSIL                  | U3  | ZL8802ALAFT     |
| 48   | 2   | CL05B152KB5NFNC   | CAP,CER,X7R,5.6nF,50VDC,10%,-10%,0402        | SAMSUNG ELECTRO-MECHANICS | C7      C27   | CL05B152KB5NFNC |
| 49   | 1   | CL05B152KB5NFNC   | CAP,CER,X7R,470pF,50VDC,10%,-10%,0402        | SAMSUNG ELECTRO-MECHANICS | C37   | CL05B152KB5NFNC |
| 50   | 3   | CC0603KRX7R8BB563 | CAP,CER,X7R,1μF,16VDC,10%,-10%,0603          | YAGEO                     | C9 C39      C29   | CC 0603 X7R     |
| 51   | 14  | CL21B105KAFNFNE   | CAP,CER,X7R,10μF,16VDC,20%,-20%,0805         | SAMSUNG ELECTRO-MECHANICS | C1 C4 C21 C24 C32      C2 C5 C22 C25 C34      C3 C6 C23 C26 | CL21B105KAFNFNE |

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| Item | Qty | Manufacture P/N    | Description                                     | Manufacture               | Reference          | Part                |
|------|-----|--------------------|---|---------------------------|--------------------|---------------------|
| 52   | 2   | CL05B152KB5NFC     | CAP,CER,X7R,1µF, 6.3VDC,10%,-10%,0402           | SAMSUNG ELECTRO-MECHANICS | C30 C38            | CL05B152KB5NF NC    |
| 53   | 2   | 0805B102K102CT     | CAP,CER,X7R,10µF,6.3VDC,10%,-10%,0805           | WALSIN                    | C31 C33            | 0805B102K102CT      |
| 54   | 2   | GRM0335C1E680JA01D | CAP,CER,C0G/NP0, 68pF,25VDC,5%, -5%,0201        | MURATA                    | C35 C36            | GRM0335C1E680 JA01D |
| 55   | 2   | EMK063C7104KPQF    | CAP,CER,X7S,100nF, 16VDC,10%,-10%, 0201         | TAIYO YUDEN               | C8 C28             | EMK063C7104KP QF    |
| 56   | 1   | RM04FTN5R10        | RES,DIS,TKF,1KΩ, 0.063W,1%,100ppm [TC],0402     | TA-I                      | R33                | RM04FTN5R10         |
| 57   | 3   | 0402WGF1803TCE     | RES,DIS,TKF,10KΩ, 0.063W,1%,100ppm [TC],0402    | ROYAL                     | R37 R39 R40        | 0402WGF1803TC E     |
| 58   | 2   | RC0402FR-0749K9L   | RES,DIS,TKF,100KΩ, 0.063W,1%,100ppm [TC],0402   | YAGEO                     | R3 R23             | RC0402FR-0749K9L    |
| 59   | 1   | RM04FTN5R10        | RES,DIS,TKF,3.48KΩ, 0.063W,1%,100ppm [TC],0402  | TA-I                      | R32                | RM04FTN5R10         |
| 60   | 1   | 0402WGF1803TCE     | RES,DIS,TKF,38.3KΩ, 0.063W,1%,100ppm [TC],0402  | ROYAL                     | R36                | 0402WGF1803TC E     |
| 61   | 4   | RC0402FR-0749K9L   | RES,DIS,TKF,47Ω, 0.063W,1%,100ppm [TC],0402     | YAGEO                     | R31 R38<br>R41 R42 | RC0402              |
| 62   | 2   | RT0402BRD073K9L    | RES,DIS,TNF,1.05KΩ, 0.063W,0.1%,25ppm [TC],0402 | YAGEO USA (HK) LTD        | R2 R22             | RT0402              |
| 63   | 2   | RT0402BRD073K9L    | RES,DIS,TNF,221Ω,0.063W,0.1%,25ppm [TC],0402    | YAGEO USA (HK) LTD        | R1 R21             | RT0402              |

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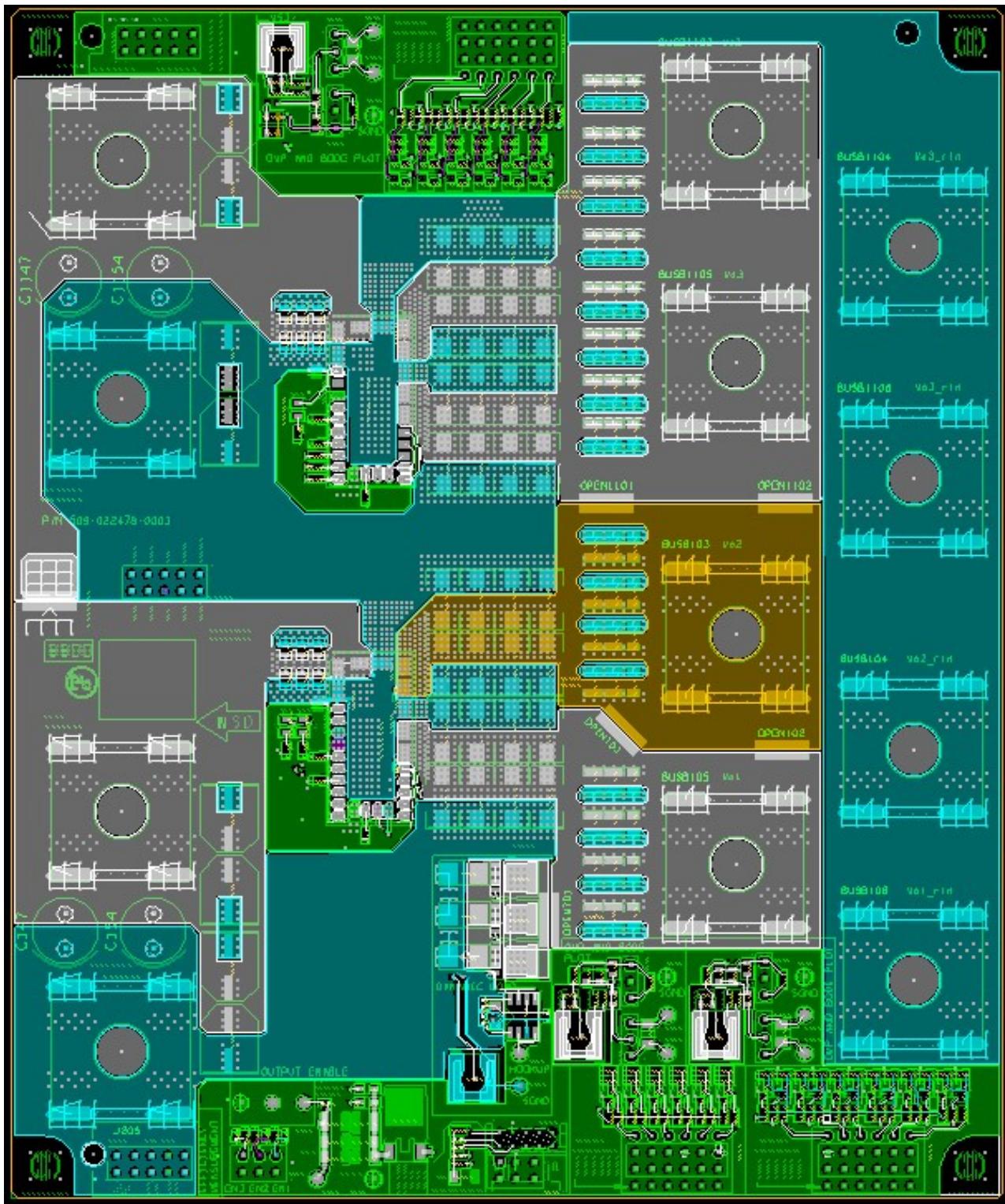
| Item | Qty | Manufacture P/N   | Description                                    | Manufacture           | Reference | Part              |
|------|-----|-------------------|--|-----------------------|-----------|-------------------|
| 64   | 2   | RMCS0402FT100K-AS | RES,DIS,TKFS,1.4KΩ, 0.063W,1%,200ppm [TC],0402 | STACKPOLE ELECTRONICS | R5 R25    | RMCS0402FT100K-AS |
| 65   | 2   | SG73S1ETTP4R70F   | RES,DIS,TKF,4.7Ω, 0.125W,1%,200ppm [TC],0402   | KOA                   | R7 R27    | SG73S1ETTP4R70F   |
| 66   | 2   | RK73H1HTTC3320F   | RES,DIS,TKF,10KΩ, 0.05W,1%,200ppm [TC],0201    | KOA SPEER ELECTRONICS | R4 R24    | RK73H1HTTC3320F   |

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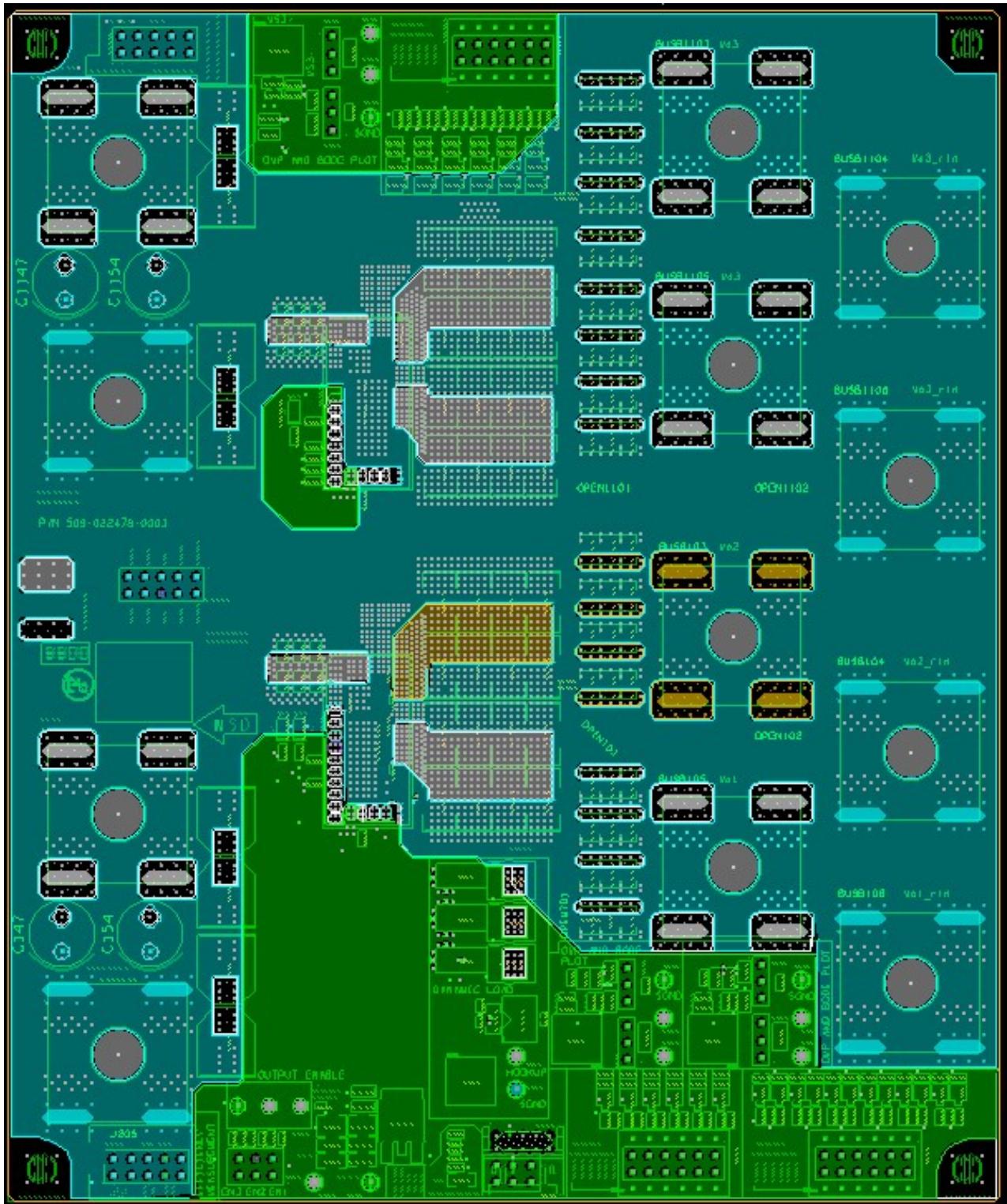
# PCB Layout

## Top copper



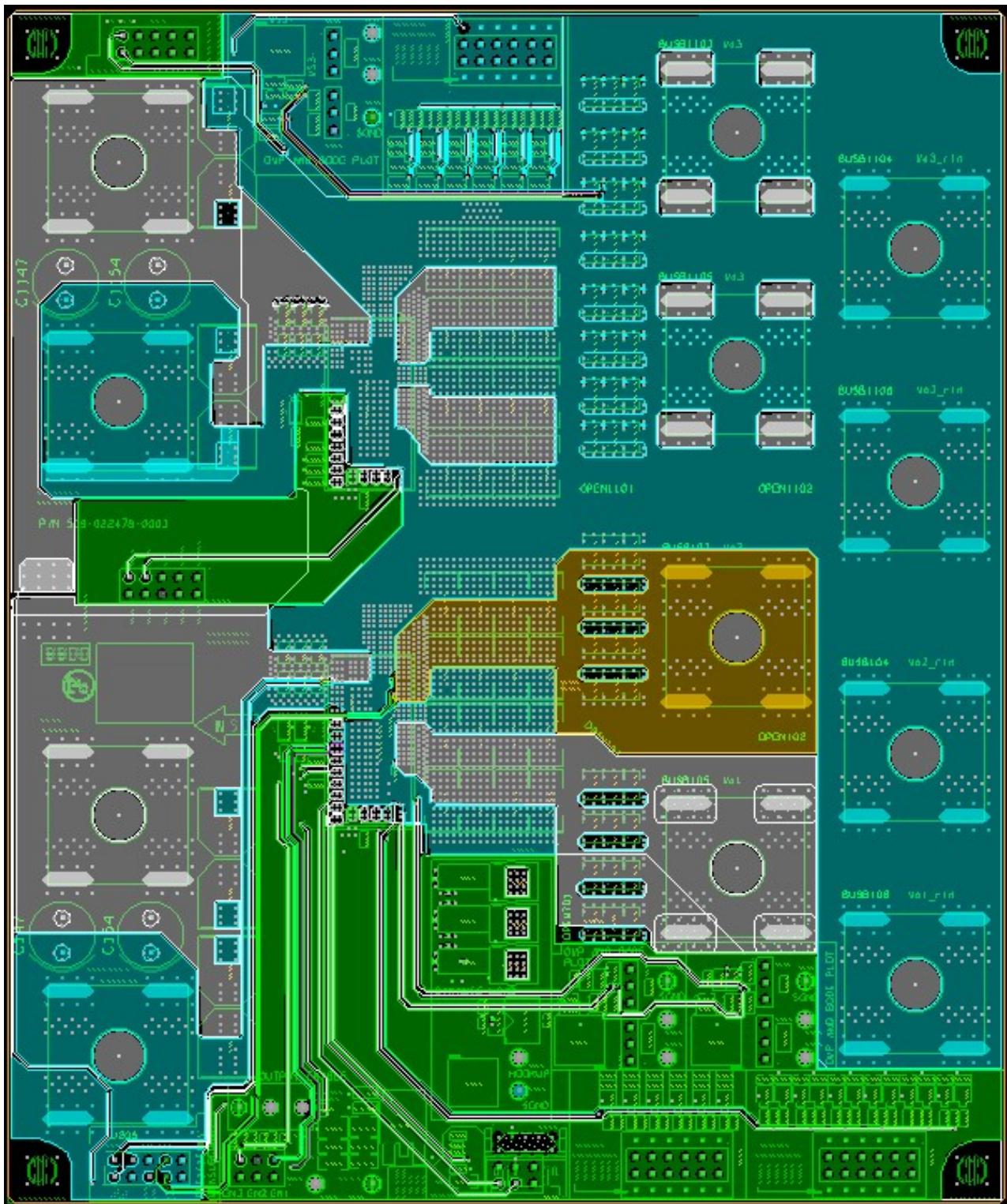
## PCB Layout

### Layer 2 copper



## PCB Layout

### Layer 3 copper

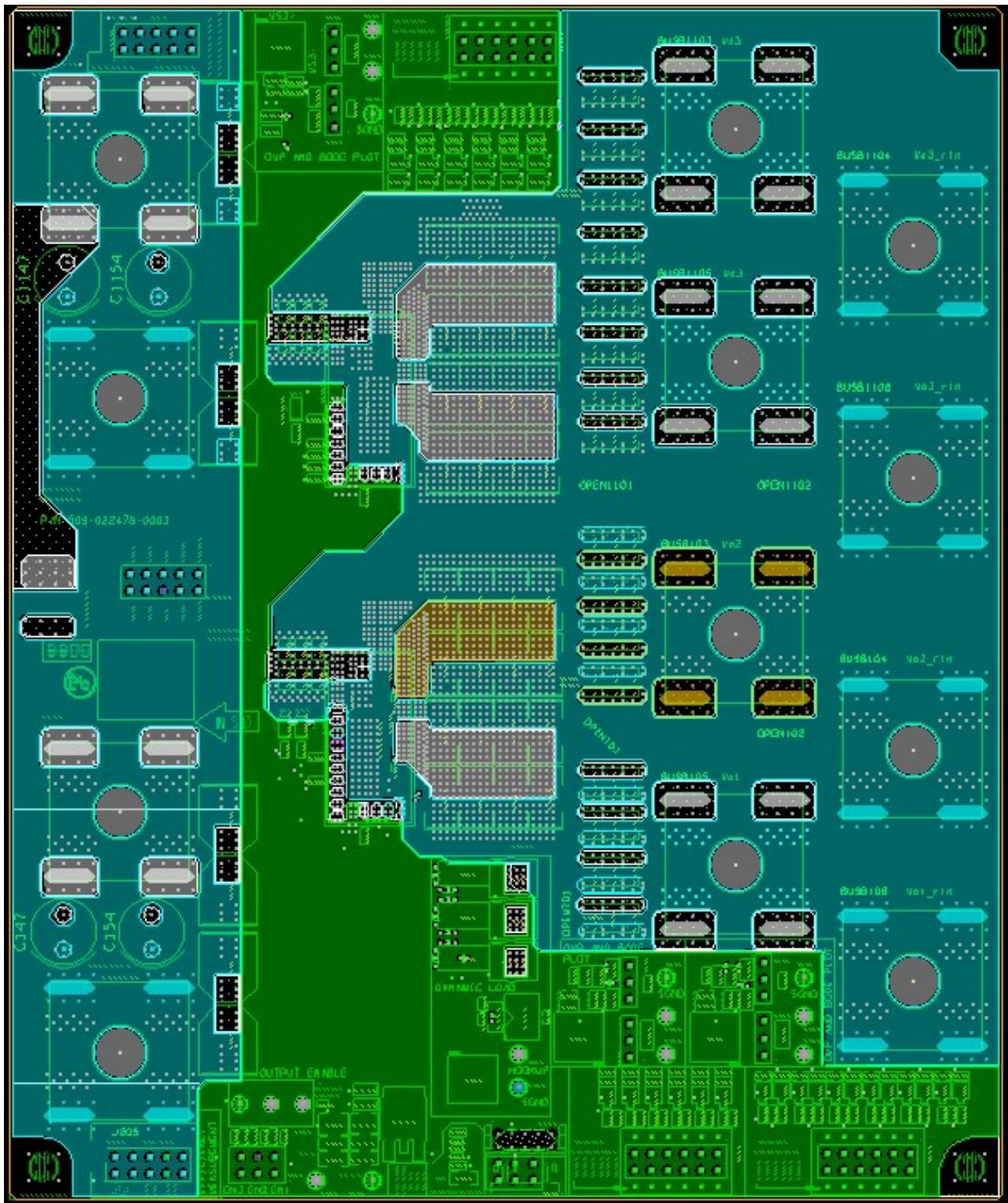


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# PCB Layout

## Layer 4 copper

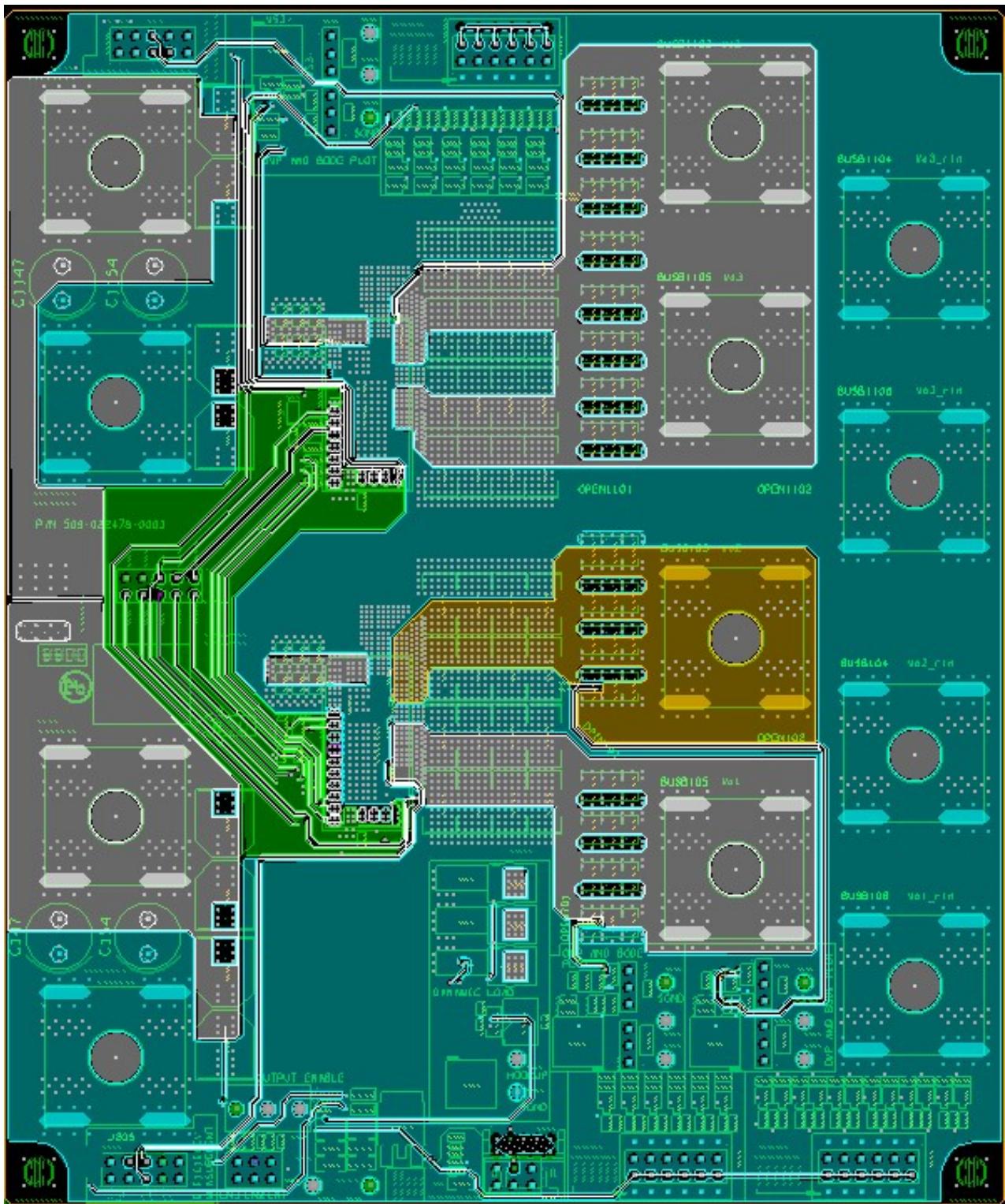


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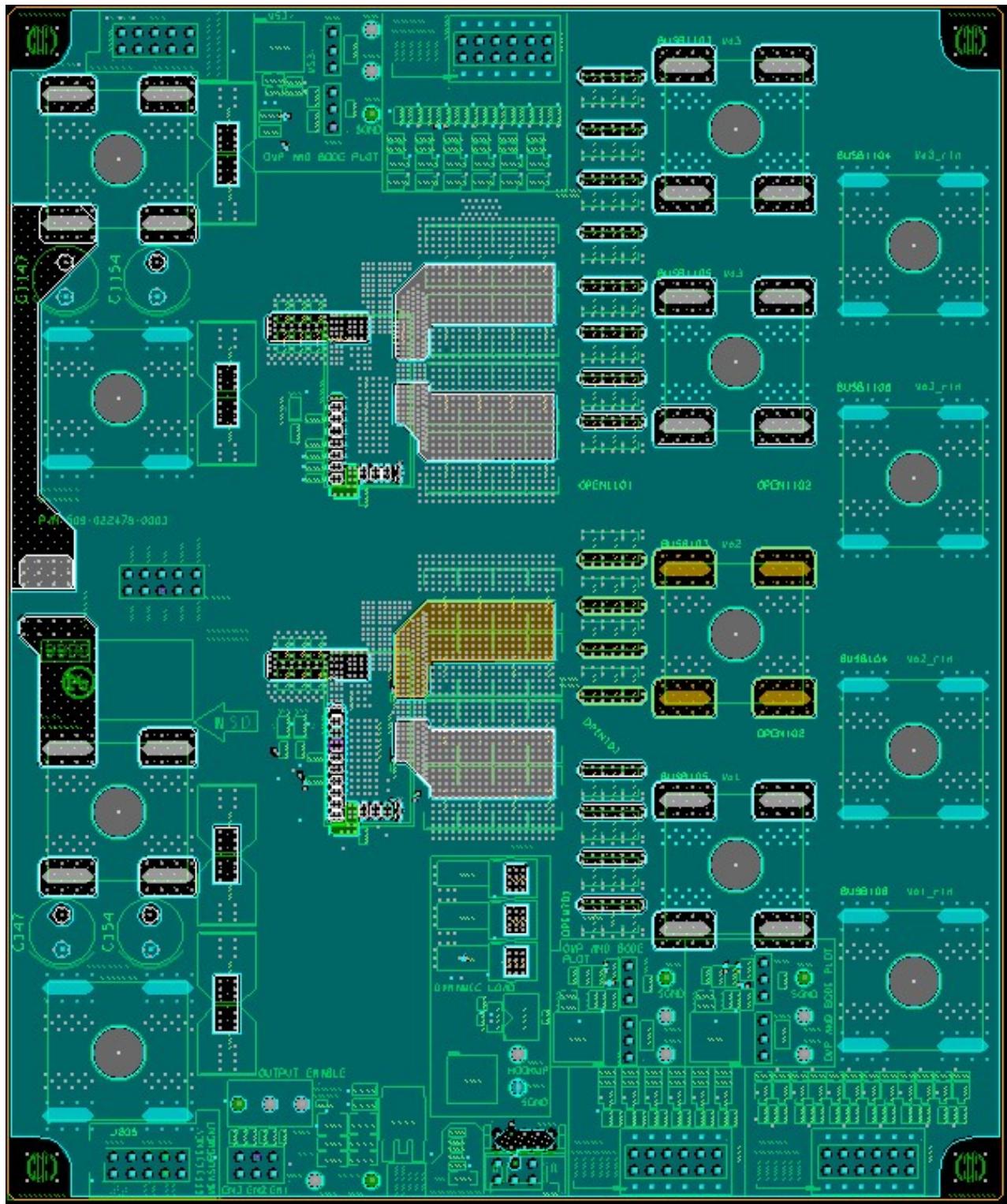
# PCB Layout

## Layer 5 copper



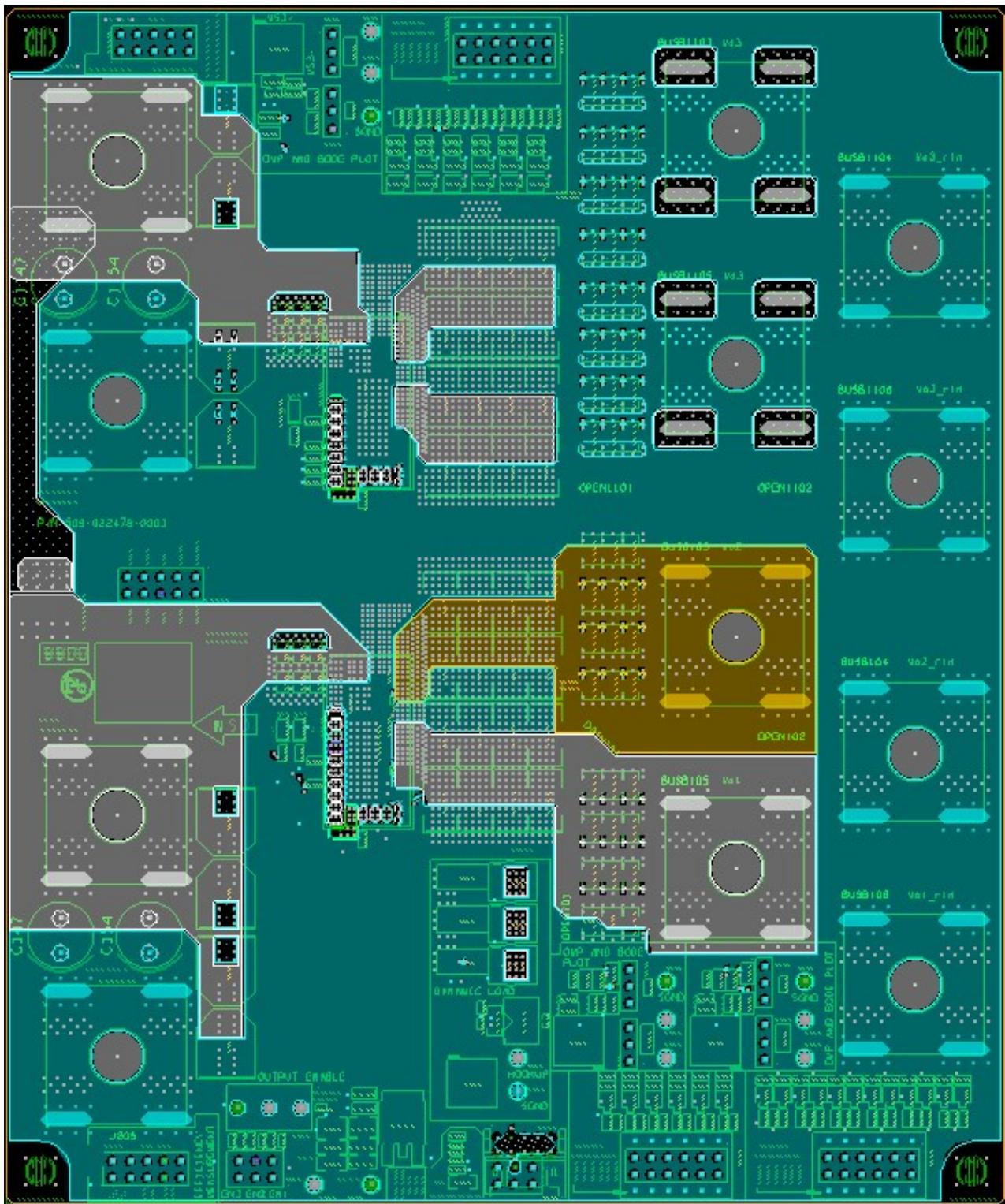
## PCB Layout

### Layer 6 copper



## PCB Layout

### Layer 7 copper

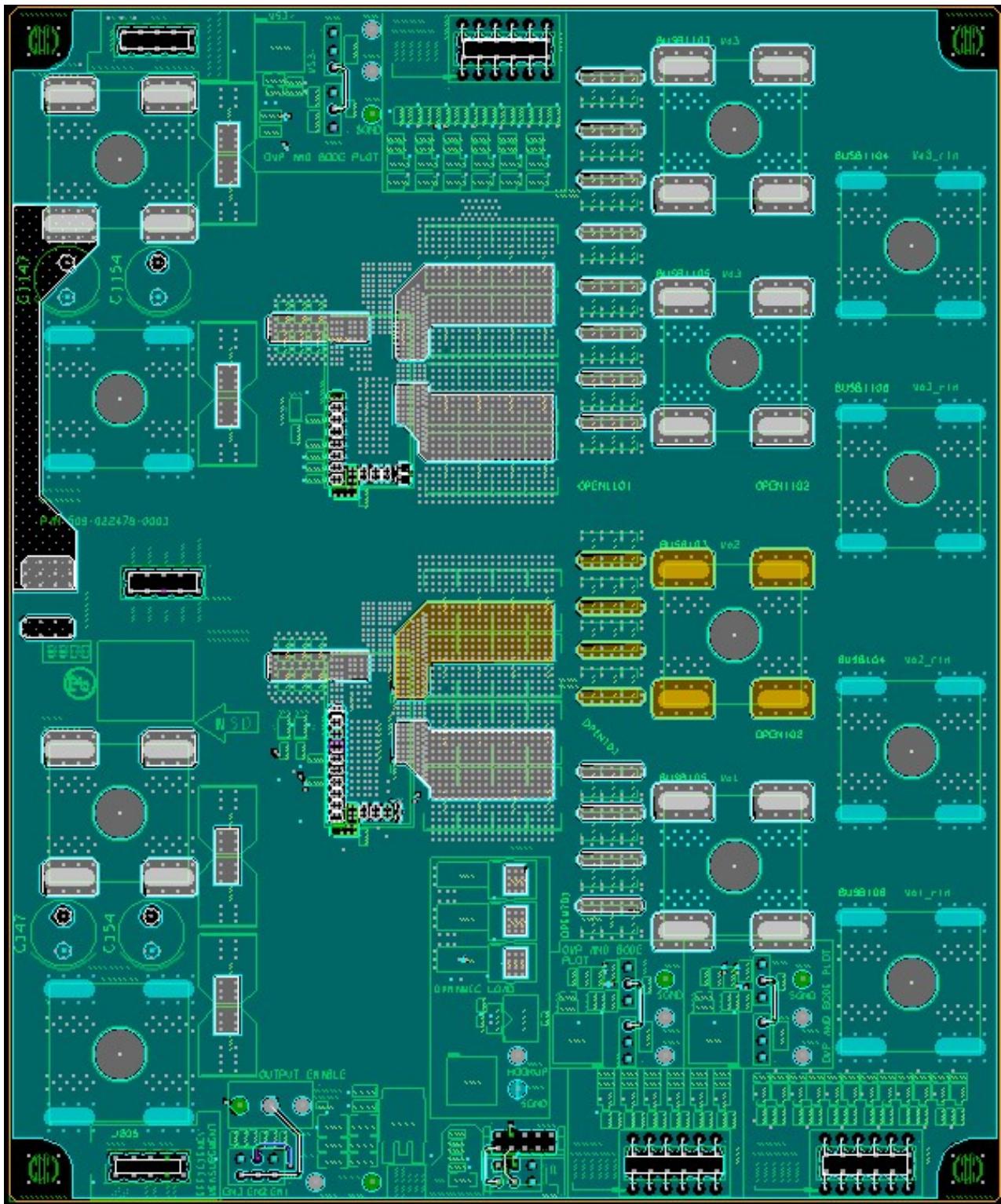


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# PCB Layout

## Bottom copper



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### Record of Revision and Changes

| Issue | Date       | Description | Originators |
|-------|------------|-------------|-------------|
| 1.0   | 11.06.2019 | First Issue | J. Ma       |

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